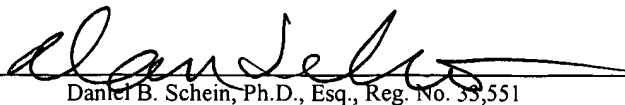
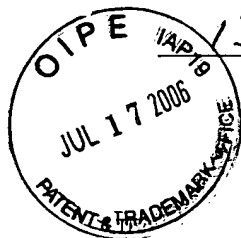


IFW

I hereby certify that this correspondence is being deposited with the United States Postal Service, with sufficient postage, as first class mail in an envelope addressed to, Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450, or submitted via facsimile to 571-273-8300 if the following box is checked ☐, on the date indicated below:


Daniel B. Schein, Ph.D., Esq., Reg. No. 33,551



13 July 2006
Date of Signature

Our Case No.: 11445-8

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: LIN, Shi-Tron

Serial No.: 10/797,998

Filing Date: March 10, 2004

For: INTERCONNECT STRUCTURE
OF A CHIP AND A
CONFIGURATION METHOD
THEREOF

Examiner: Stacy WHITMORE

Group Art Unit No.: 2825

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY AND AMENDMENT

Dear Sir:

This is in timely response to the Official Action mailed April 13, 2006. Applicants respectfully submit the following amendments and comments in connection with the above-named application.